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QRD1113 / QRD1114 Reflective Object Sensor

Features

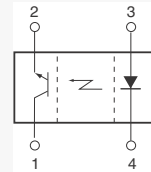
- Phototransistor Output
- No-Contact Surface Sensing
- Unfocused for Sensing Diffused Surfaces
- Compact Package
- Daylight Filter on sensor

Description

The QRD1113 and QRD1114 reflective sensors consist of an infrared emitting diode and an NPN silicon phototransistor mounted side by side in a black plastic housing. The on-axis radiation of the emitter and the on-axis response of the detector are both perpendicular to the face of the QRD1113 and QRD1114. The phototransistor responds to radiation emitted from the diode only when a reflective object or surface is in the field of view of the detector.



Schematic



PIN 1. Collector PIN 3. Anode
PIN 2. Emitter PIN 4. Cathode

Ordering Information

| Part Number | Operating Temperature | Package | Top Mark | Packing Method |
|-------------|-----------------------|-----------|----------|----------------|
| QRD1113 | -40 to +85°C | Custom 4L | QRD1113 | Bulk |
| QRD1114 | | Custom 4L | QRD1114 | Bulk |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise specified.

| Symbol | Parameter | Min. | Unit |
|--------------------|---|--------------|------|
| T_{OPR} | Operating Temperature | -40 to +85 | °C |
| T_{STG} | Storage Temperature | -40 to + 100 | |
| $T_{\text{SOL-I}}$ | Lead Temperature (Solder Iron) ^(1,2,3) | 240 for 5 s | |
| $T_{\text{SOL-F}}$ | Lead Temperature (Solder Flow) ^(1,2) | 260 for 10 s | |
| EMMITER | | | |
| I_F | Continuous Forward Current | 50 | mA |
| V_R | Reverse Voltage | 5 | V |
| P_D | Power Dissipation | 100 | mW |
| SENSOR | | | |
| V_{CEO} | Collector-Emitter Voltage | 30 | V |
| V_{ECO} | Emitter-Collector Voltage | | V |
| P_D | Power Dissipation ⁽⁴⁾ | 100 | mW |

Notes:

1. RMA flux is recommended.
2. Methanol or isopropyl alcohols are recommended as cleaning agents.
3. Soldering iron tip 1/16 inch (1.6 mm) minimum from housing.
4. Derate power dissipation linearly 1.33 mW/°C.

Electrical / Optical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless specified otherwise.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|------------------------|--------------------------------------|---|-------|------|------|---------------|
| INPUT (Emitter) | | | | | | |
| V_F | Forward Voltage | $I_F = 20\text{ mA}$ | | | 1.7 | V |
| I_R | Reverse Leakage Current | $V_R = 5\text{ V}$ | | | 100 | μA |
| λ_{PE} | Peak Emission Wavelength | $I_F = 20\text{ mA}$ | | 940 | | nm |
| OUTPUT (Sensor) | | | | | | |
| BV_{CEO} | Collector-Emitter Breakdown | $I_C = 1\text{ mA}$ | 30 | | | V |
| BV_{ECO} | Emitter-Collector Breakdown | $I_E = 0.1\text{ mA}$ | 5 | | | V |
| I_D | Dark Current | $V_{CE} = 10\text{ V}, I_F = 0\text{ mA}$ | | | 100 | nA |
| COUPLED | | | | | | |
| $I_{C(ON)}$ | QRD1113 Collector Current | $I_F = 20\text{ mA}, V_{CE} = 5\text{ V},$ $D = 0.050\text{ inch}^{(5, 7)}$ | 0.300 | | | mA |
| $I_{C(ON)}$ | QRD1114 Collector Current | | 1 | | | mA |
| $V_{CE(SAT)}$ | Collector Emitter Saturation Voltage | $I_F = 40\text{ mA}, I_C = 100\text{ }\mu\text{A},$ $D = 0.050\text{ inch}^{(5, 7)}$ | | | 0.4 | V |
| I_{CX} | Cross Talk | $I_F = 20\text{ mA}, V_{CE} = 5\text{ V},$ $E_E = 0^{(6)}$ | | 0.2 | 10.0 | μA |
| t_r | Rise Time | $V_{CE} = 5\text{ V}, R_L = 100\text{ }\Omega,$ $I_{C(ON)} = 5\text{ mA}$ | | 10 | | μs |
| t_f | Fall time | | | 50 | | μs |

Notes:

5. D is the distance from the sensor face to the reflective surface.
6. Crosstalk (I_{CX}) is the collector current measured with the indicated current on the input diode and with no reflective surface.
7. Measured using Eastman Kodak natural white test card with 90% diffused reflecting as a reflecting surface.

Typical Performance Characteristics

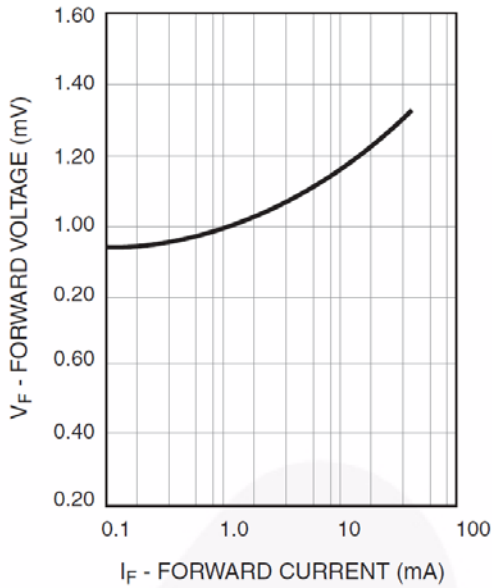


Figure 1. Forward Voltage vs. Forward Current

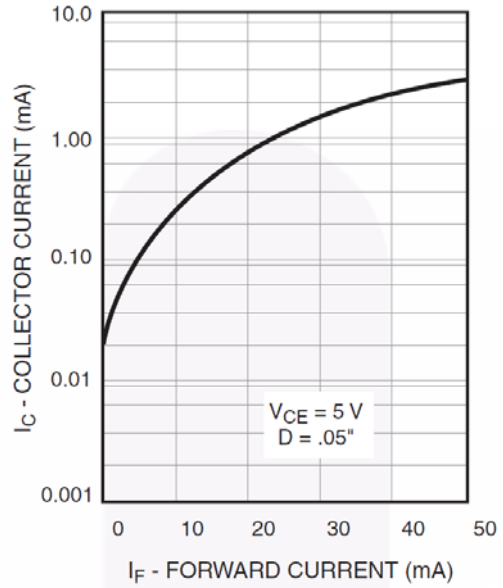


Figure 2. Normalized Collector Current vs. Forward Current

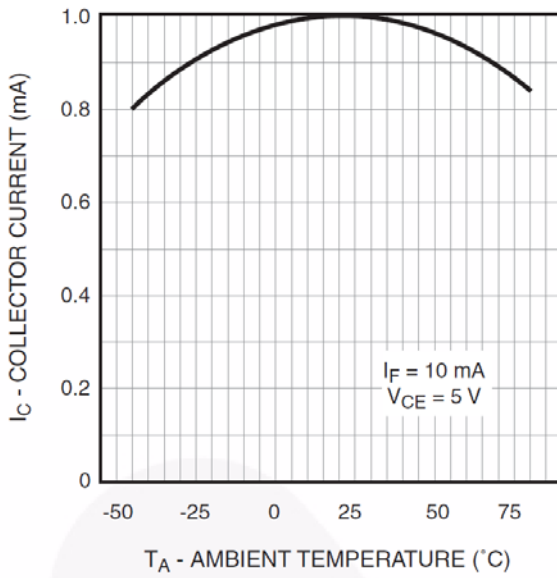


Figure 3. Normalized Collector Current vs. Temperature

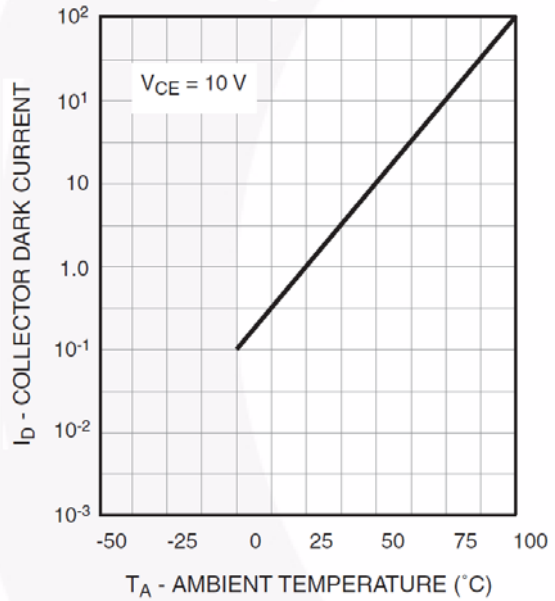


Figure 4. Normalized Collector Dark Current vs. Temperature

Typical Performance Characteristics (continued)

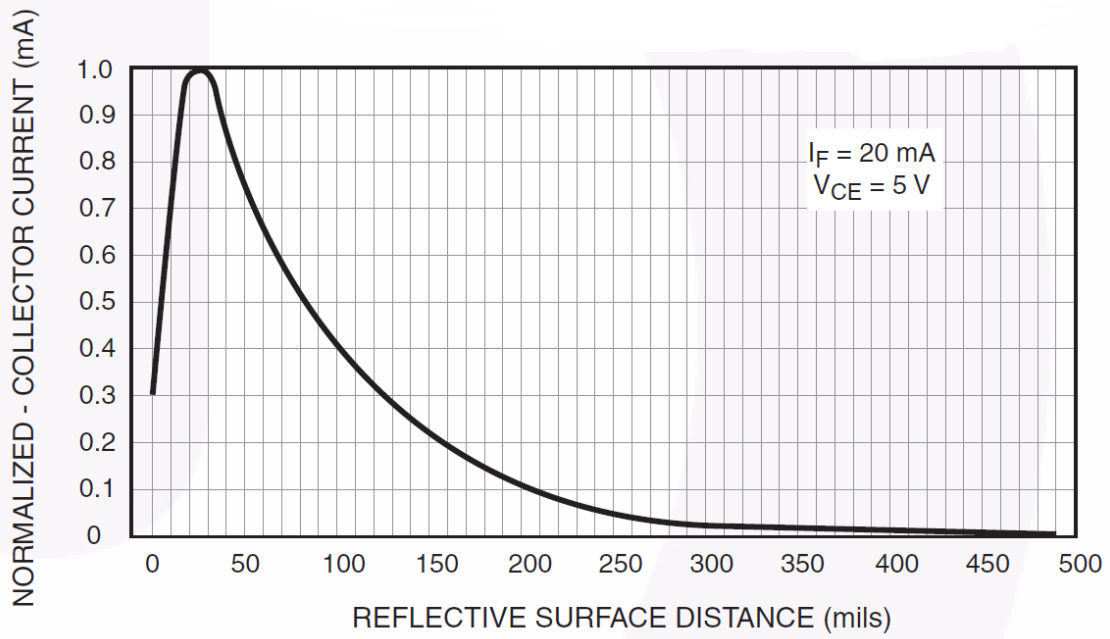
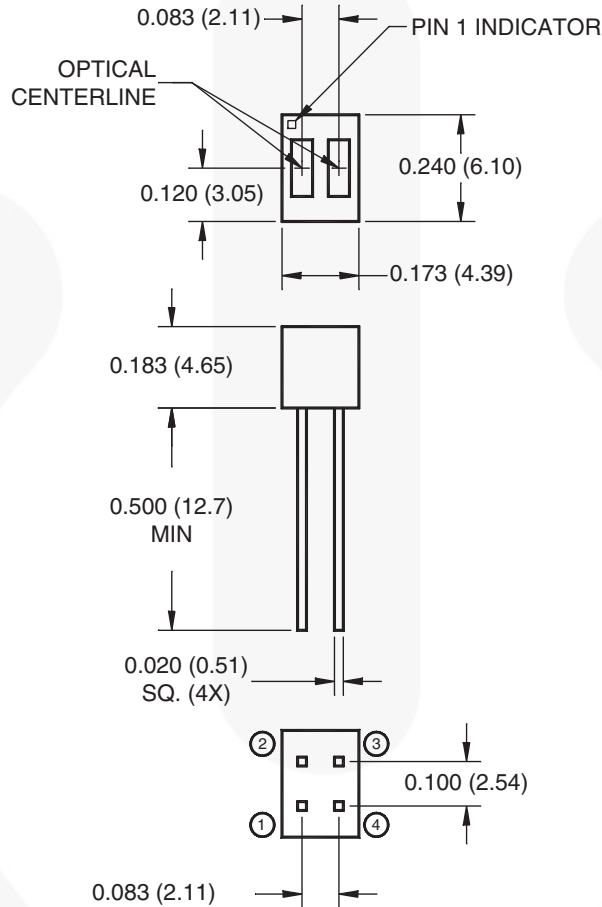


Figure 5. Normalized Collector Current vs. Distance

Physical Dimensions

Custom 4L



Notes:

1. Dimensions for all drawings are in inches (millimeters).
2. Tolerance of $\pm .010$ (.25) on all non-nominal dimensions unless otherwise specified.
3. Pins 2 and 4 typically .050" shorter than pins 1 and 3.
4. Dimensions controlled at housing surface.

Figure 6. REFLECTIVE RECTANGULAR SENSOR PCB MOUNT (ACTIVE)

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